

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2989032

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NPL ASSOCIATES, INC.	07/08/2014
RECEIVING PARTY DATA	
Name:	LENUCO, LLC
Street Address:	912 WEST ARMORY AVENUE
City:	CHAMPAIGN
State/Country:	ILLINOIS
Postal Code:	61821
PROPERTY NUMBERS Total: 4	
Property Type	Number
Patent Number:	8227020
Patent Number:	8440165
Patent Number:	8526560
Patent Number:	8603405
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	NPLLENUCO
NAME OF SUBMITTER:	ALAN R. SINGLETON
SIGNATURE:	/Alan R. Singleton/
DATE SIGNED:	08/20/2014
Total Attachments: 2	
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ASSIGNMENT

NPL Associates, Inc. ("Assignor"), located at 912 W Armory Av, Champaign, IL, 61821, hereby assigns to Lenuco, LLC, all of its right, title, and interest in and to the Exclusive License Agreement ("Agreement") entered into on May 25, 2012 between Assignor and The Board of Trustees of the University of Illinois ("Illinois") concerning the following University Patent Rights:

1) POWER UNITS BASED ON DISLOCATION SITE TECHNIQUES, for which patent application for Letters Patent of the United States was filed on May 13, 2013, and accorded Serial No. 13/892,879, now U.S. Patent No. 8,603,405, issued on Dec 10, 2013, OTM reference TF 12025-CIP;

2) DISLOCATION SITE DENSITY TECHNIQUES, for which patent application for Letters Patent of the United States was filed on March 7, 2012, and accorded Serial No. 13/414,300, now U.S. Patent No. 8,440,165, issued on May 14, 2013, OTM reference TF12025;

3) DISLOCATION SITE FORMATION TECHNIQUES, for which patent application for Letters Patent of the United States was filed March 31, 2008, and accorded Serial No. 2/080,011, now U.S. Patent No. 8,227,020, issued on July 24, 2012, OTM reference TF12026;

4) METHOD OF USING DEUTERIUM-CLUSTER FOILS FOR AN INTENSE PULSED NEUTRON SOURCE, for which patent application for Letters Patent of the United States was filed on November 8, 2012, and accorded Serial No. 13/672,134, now U.S. Patent No. 8,526,560, issued on Sep 3, 2013, OTM reference TF12078.

Dated this 8th day of ~~June~~ ^{July} 2014.

ASSIGNOR: NPL ASSOCIATES, INC.

By: Genge H Miley, President NPL
[insert name and title]

ACCEPTANCE OF ASSIGNMENT

Assignee hereby accepts the foregoing assignment of the Agreement and agrees to be bound by and perform all the obligations of Assignor thereunder. For purpose of Section 8.3 of the Agreement, Assignees' address and contact information is:

Dated this 8th day of ~~June~~ ^{July} 2014.

912 W. Armory Ave
Champaign IL 61821

ASSIGNEE: Lenuco, LLC

email: ghmiley@illinois.edu

By: Genge H Miley, Manager, Lenuco
[insert name and title]

CONSENT TO ASSIGNMENT

The Board of Trustees of the University of Illinois hereby consents to the foregoing Assignment of the Agreement.

Dated this 8th day of Aug, 2014.

**THE BOARD OF TRUSTEES OF
THE UNIVERSITY OF ILLINOIS**

By: Walter K Knorr
Walter K. Knorr, Comptroller

Attest: Susan M. Kies
Susan M. Kies, Secretary